

NPN MEDIUM POWER TRANSISTORS IN SOT89

Features

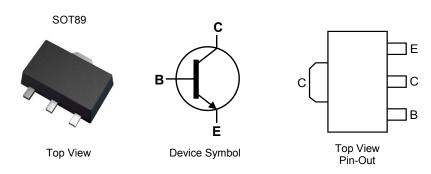
- BV_{CEO} > 45V, 60V & 80V
- I_C = 1A Continuous Collector Current
- I_{CM} = 2A Peak Pulse Current
- Low Saturation Voltage V_{CE(sat)} < 500mV @ 0.5A
- Gain Groups 10 and 16
- Epitaxial Planar Die Construction
- Complementary PNP Types: BCX51, 52, and 53
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
 For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Leads.
 Solderable per MIL-STD-202 Method 208 (2)
- Weight: 0.055 grams (Approximate)

Applications

- Medium Power Switching or Amplification Applications
- AF Driver and Output Stages



Ordering Information (Note 4)

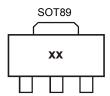
Product	Compliance	Maukina	Deal size (inches)	Tana width (mm)	Oughtitu ner reel
	Compliance	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
BCX54TA	Standard	BA	7	12	1,000
BCX5410TA	Standard	BC	7	12	1,000
BCX5416TA	Standard	BD	7	12	1,000
BCX5416-13R	Standard	BD	13	12	4,000
BCX55TA	Standard	BE	7	12	1,000
BCX5510TA	Standard	BG	7	12	1,000
BCX5516TA	Standard	BM	7	12	1,000
BCX56TA	Standard	BH	7	12	1,000
BCX5610TA	Standard	BK	7	12	1,000
BCX5616TA	Standard	BL	7	12	1,000
BCX5616TC	Standard	BL	13	12	4,000
BCX5410TC	Standard	BC	13	12	4,000
BCX5416TC	Standard	BD	13	12	4,000
BCX54TC	Standard	BA	13	12	4,000
BCX5510TC	Standard	BG	13	12	4,000
BCX5516TC	Standard	BM	13	12	4,000
BCX55TC	Standard	BE	13	12	4,000
BCX5610TC	Standard	BK	13	12	4,000
BCX56TC	Standard	BH	13	12	4,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information



xx = Product Type Marking Code, as follows:

BCX54 = BA BCX55 = BE BCX56 = BH BCX5410 = BC BCX5510 = BG BCX5610 = BK BCX5416 = BD BCX5516 = BM BCX5616 = BL

Absolute Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	BCX54	BCX55	BCX56	Unit
Collector-Base Voltage	V_{CBO}	45	60	100	V
Collector-Emitter Voltage	V _{CEO}	45	60	80	V
Emitter-Base Voltage	V_{EBO}		6		V
Continuous Collector Current	Ic	1		Α	
Peak Pulse Collector Current	I _{CM}	2			
Continuous Base Current	I _B	100		m A	
Peak Pulse Base Current	I _{BM}	200			mA

Thermal Characteristics (@ TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
	(Note 5)		1	
Power Dissipation	(Note 6)	P _D	1.5	W
	(Note 7)		2.0	
	(Note 5)		125	
Thermal Resistance, Junction to Ambient Air	(Note 6)	$R_{ heta JA}$	83	°C/W
	(Note 7)		60	
Thermal Resistance, Junction to Lead	(Note 8)	R _{0JL}	13	°C/W
Thermal Resistance, Junction to Case	(Note 9)	R ₀ JC	27	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C	

ESD Ratings (Note 10)

Notes:

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge - Human Body Model	ESD HBM	4,000	V	3A
Electrostatic Discharge - Machine Model	ESD MM	400	V	С

5. For a device mounted with the exposed collector pad on 15mm x 15mm 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured

under still-air conditions whilst operating in a steady-state.

^{6.} Same as Note 5, except the device is mounted on 25mm x 25mm 1oz copper. 7. Same as Note 5, except the device is mounted on 50mm x 50mm 1oz copper.

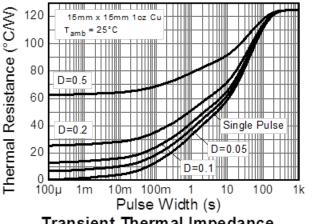
^{8.} Thermal resistance from junction to solder-point (on the exposed collector pad).

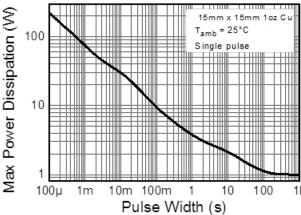
^{9.} Thermal resistance from junction to the top of the case.

^{10.} Refer to JEDEC specification JESD22-A114 and JESD22-A115.

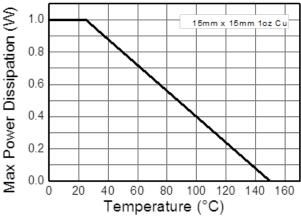


Thermal Characteristics and Derating Information



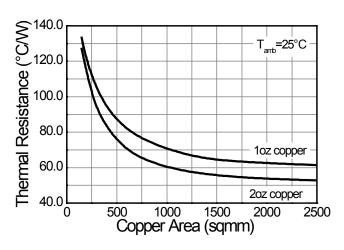


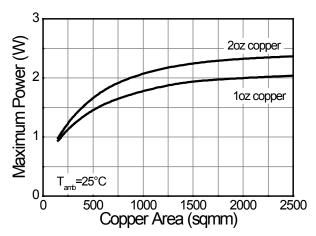
Transient Thermal Impedance



Pulse Power Dissipation

Derating Curve





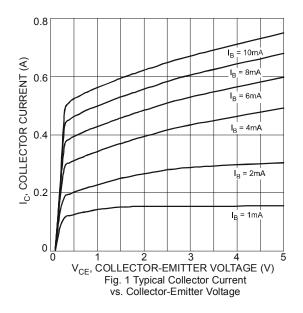


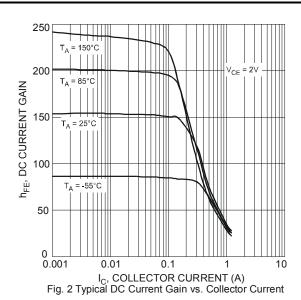
Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base	BCX54		45	_	_	٧	I _C = 100μA
Breakdown Voltage	BCX55	BV_CBO	60				
Breakdown voltage	BCX56		100				
Collector-Emitter	BCX54		45	_	_		
Breakdown Voltage (Note 11)	BCX55	BV _{CEO}	60			V	I _C = 10mA
Breakdown Voltage (Note 11)	BCX56		80				
Emitter-Base Breakdown Voltage		BV_{EBO}	6	_	_	V	I _E = 100μA
Collector Cut-Off Current		Ісво	_		0.1 20	μΑ	V _{CB} = 30V
Collector Cut-On Current							$V_{CB} = 30V, T_A = +150$ °C
Emitter Cut-Off Current		I_{EBO}	_	_	20	nA	V _{EB} = 5V
		h _{FE}	25	_	_	_	I _C = 5mA, V _{CE} = 2V
	All versions		40	_	250		$I_C = 150 \text{mA}, V_{CE} = 2 \text{V}$
Static Forward Current Transfer Ratio (Note 11)			25	_	_		I_C = 500mA, V_{CE} = 2V
Ratio (Note 11)	10 gain grp		63	_	160		I_C = 150mA, V_{CE} = 2V
	16 gain grp		100	_	250		I _C = 150mA, V _{CE} = 2V
Collector-Emitter Saturation Voltage (Note 11)		V _{CE(sat)}	_	_	0.5	V	I _C = 500mA, I _B = 50mA
Base-Emitter Turn-On Voltage (Note 11)		V _{BE(on)}	_	_	1.0	V	I _C = 500mA, V _{CE} = 2V
Transition Frequency		f⊤	150	_	_	MHz	I _C = 50mA, V _{CE} = 10V f = 100MHz
Output Capacitance		Cobo	_	_	25	pF	V _{CB} = 10V, f = 1MHz

Note:

Typical Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

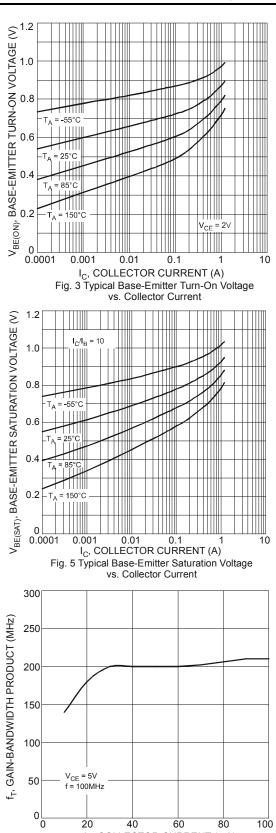




^{11.} Measured under pulsed conditions. Pulse width ≤ 300µs. Duty cycle ≤ 2%.



Typical Electrical Characteristics (continued)



60

I_C, COLLECTOR CURRENT (mA) Fig. 7 Typical Gain-Bandwidth Product vs. Collector Current

40

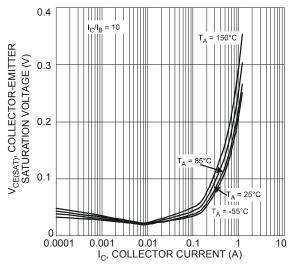


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

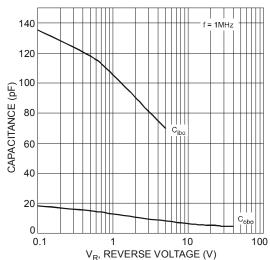


Fig. 6 Typical Capacitance Characteristics

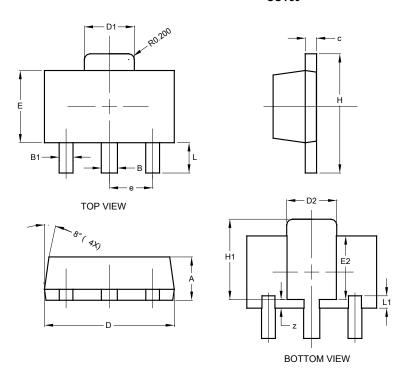
100



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89

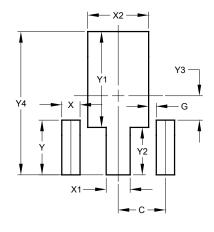


SOT89							
Dim	Min	Max	Тур				
Α	1.40	1.60	1.50				
В	0.50	0.62	0.56				
B1	0.42	0.54	0.48				
С	0.35	0.43	0.38				
D	4.40	4.60	4.50				
D1	1.62	1.83	1.733				
D2	1.61	1.81	1.71				
Е	2.40	2.60	2.50				
E2	2.05	2.35	2.20				
е	ı	ı	1.50				
Н	3.95	4.25	4.10				
H1	2.63	2.93	2.78				
L	0.90	1.20	1.05				
L1	0.327	0.527	0.427				
Z	0.20	0.40	0.30				
All Dimensions in mm							

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT89



Dimensions	Value (in mm)		
С	1.500		
G	0.244		
Х	0.580		
X1	0.760		
X2	1.933		
Υ	1.730		
Y1	3.030		
Y2	1.500		
Y3	0.770		
Y4	4.530		



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